



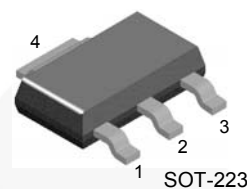
October 2014

# FJT44

## NPN Epitaxial Silicon Transistor

### Features

- High-Voltage Transistor



1. Base 2,4. Collector 3. Emitter

### Ordering Information

Part Number	Marking	Package	Packing Method, Size
FJT44TF	FJT44	SOT-223 4L	Tape and Reel, 4000 pcs
FJT44KTF	FJT44	SOT-223 4L	Tape and Reel, 2500 pcs

### Absolute Maximum Ratings<sup>(1),(2)</sup>

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at  $T_A = 25^{\circ}\text{C}$  unless otherwise noted.

Symbol	Parameter	Value	Unit
$V_{\text{CBO}}$	Collector-Base Voltage	500	V
$V_{\text{CEO}}$	Collector-Emitter Voltage	400	V
$V_{\text{EBO}}$	Emitter-Base Voltage	6	V
$I_{\text{C}}$	Collector Current	300	mA
$T_{\text{J}}$	Junction Temperature	150	$^{\circ}\text{C}$
$T_{\text{STG}}$	Storage Temperature Range	-55 to +150	$^{\circ}\text{C}$

#### Notes:

1. These ratings are based on a maximum junction temperature of  $150^{\circ}\text{C}$ .
2. These are steady-state limits. Fairchild Semiconductor should be consulted on applications involving pulsed or low-duty-cycle operations.

**Thermal Characteristics<sup>(3)</sup>**

Values are at  $T_A = 25^\circ\text{C}$  unless otherwise noted.

Symbol	Parameter	Max.	Unit
$P_D$	Power Dissipation, $T_C = 25^\circ\text{C}$	2	W
	Derate Above $25^\circ\text{C}$	16	mW/ $^\circ\text{C}$
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	62.5	$^\circ\text{C}/\text{W}$

**Note:**

3. Device is mounted on FR-4 PCB 36 mm × 18 mm × 1.5 mm; mounting pad for the collector lead minimum 6 cm<sup>2</sup>.

**Electrical Characteristics<sup>(4)</sup>**

Values are at  $T_A = 25^\circ\text{C}$  unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$BV_{CBO}$	Collector-Base Breakdown Voltage	$I_C = 100\ \mu\text{A}$ , $I_E = 0$	500			V
$BV_{CEO}$	Collector-Emitter Breakdown Voltage	$I_C = 1\ \text{mA}$ , $I_B = 0$	400			V
$BV_{EBO}$	Emitter-Base Breakdown Voltage	$I_E = 100\ \mu\text{A}$ , $I_C = 0$	6			V
$I_{CBO}$	Collector-Base Cut-Off Current	$V_{CB} = 400\ \text{V}$ , $I_E = 0$			100	nA
$I_{CES}$	Collector-Emitter Cut-Off Current	$V_{CE} = 400\ \text{V}$ , $V_{BE} = 0$			500	nA
$I_{EBO}$	Emitter-Base Cut-Off Current	$V_{EB} = 4\ \text{V}$ , $I_C = 0$			100	nA
$h_{FE}$	DC Current Gain	$V_{CE} = 10\ \text{V}$ , $I_C = 1\ \text{mA}$	40			
		$V_{CE} = 10\ \text{V}$ , $I_C = 10\ \text{mA}$	50		200	
		$V_{CE} = 10\ \text{V}$ , $I_C = 50\ \text{mA}$	45			
		$V_{CE} = 10\ \text{V}$ , $I_C = 100\ \text{mA}$	40			
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$I_C = 1\ \text{mA}$ , $I_B = 0.1\ \text{mA}$			0.40	V
		$I_C = 10\ \text{mA}$ , $I_B = 1\ \text{mA}$			0.50	
		$I_C = 50\ \text{mA}$ , $I_B = 5\ \text{mA}$			0.75	
$V_{BE(sat)}$	Base-Emitter Saturation Voltage	$I_C = 10\ \text{mA}$ , $I_B = 1\ \text{mA}$			0.75	V
$C_{obo}$	Output Capacitance	$V_{CB} = 20\ \text{V}$ , $I_E = 0$ , $f = 1.0\ \text{MHz}$			7	pF

**Note:**

4. Pulse test: pulse width  $\leq 300\ \mu\text{s}$ , duty cycle  $\leq 2.0\%$

## Typical Performance Characteristics

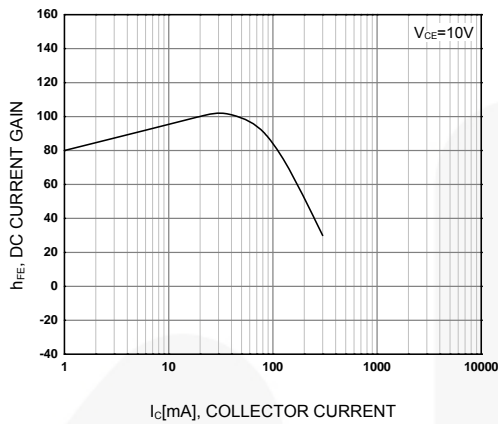


Figure 1. DC Current Gain

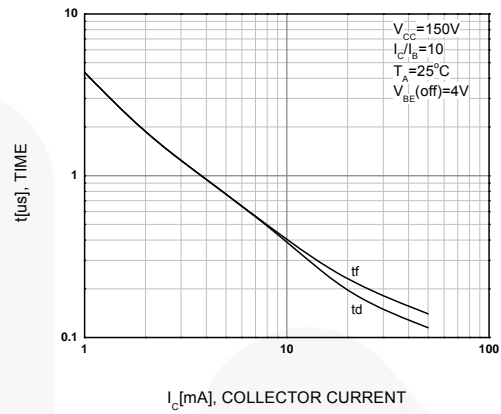


Figure 2. Turn-On Switching Times

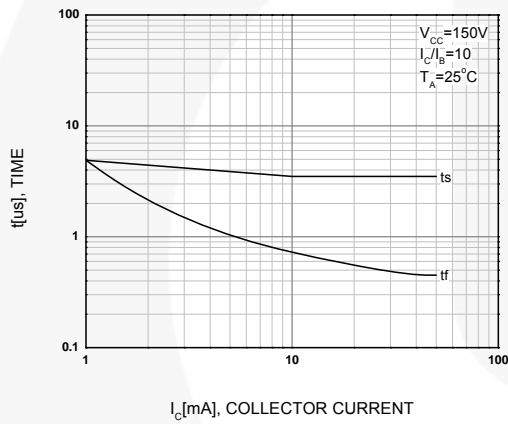


Figure 3. Turn-Off Switching Times

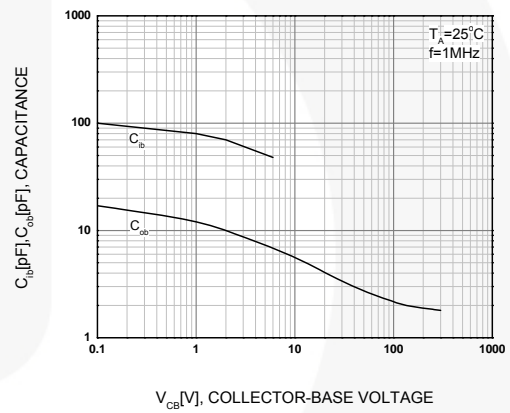


Figure 4. Capacitance

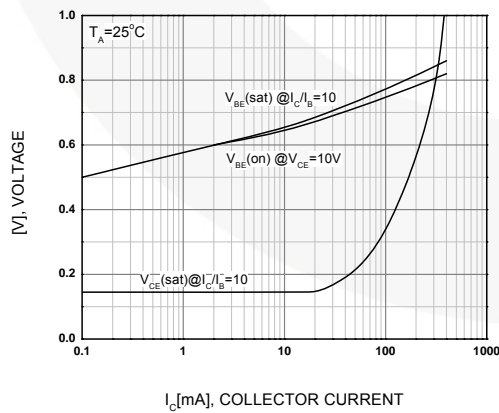


Figure 5. On Voltage

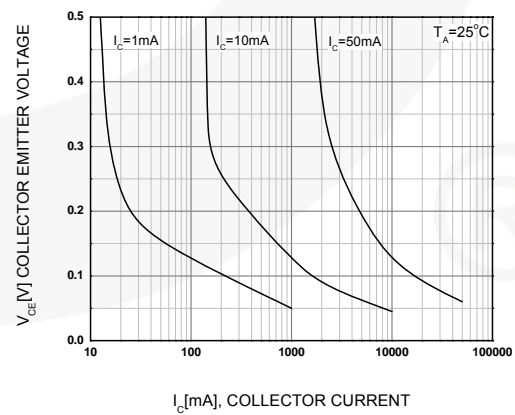


Figure 6. Collector Saturation Region

## Typical Performance Characteristics (Continued)

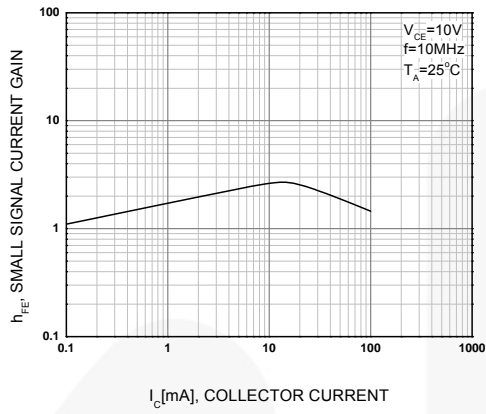
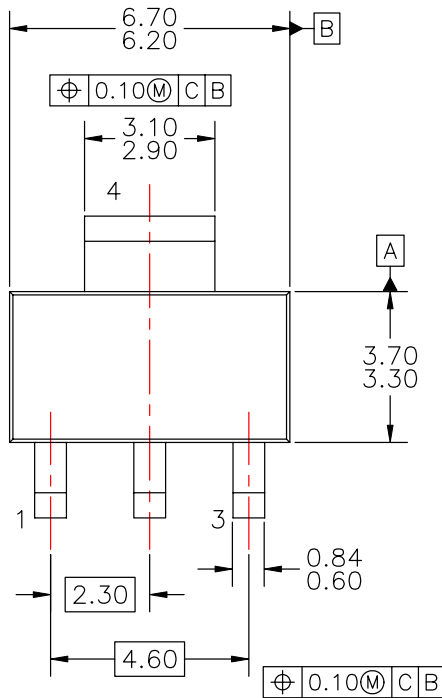


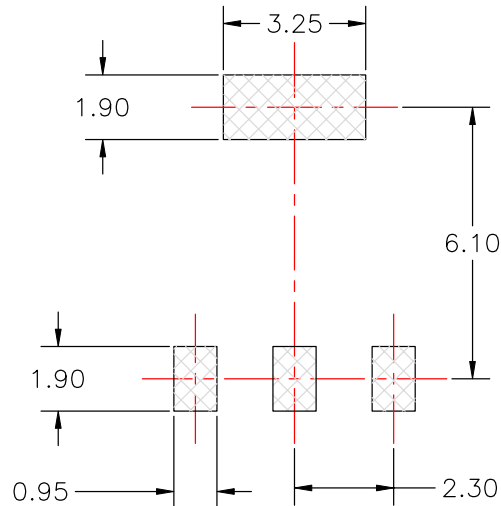
Figure 7. High Frequency Current Gain

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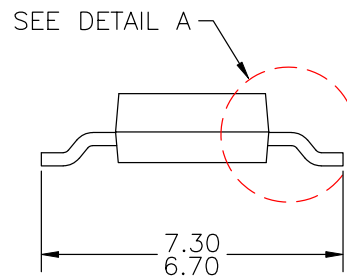
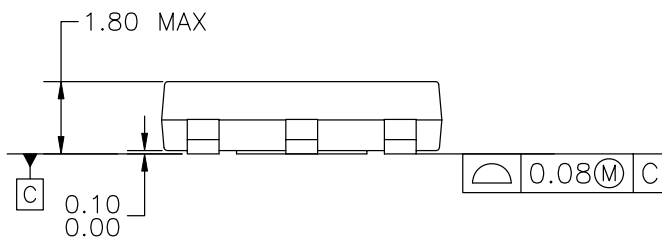
**APPROVED**  
July-14-2008



REVISIONS			
LTR	DESCRIPTION	DATE	NAME/SITE
A	RELEASE TO DOCUMENT CONTROL	JAN.25.1996	TL/FSCP
2	CHG DWG TEMPLATE FR NATIONAL TO FAIRCHILD; CHG DIM STYLE FR DUAL INCH[MM] TO SINGLE, MM; CHG LD WID FR 0.74 $\pm$ 0.05 TO 0.60-0.84; REMOVE PKG THICK DIM (1.6); CHG TOTAL PKG HT FR 1.80 TO 1.80 MAX; CHG FOOT LANDING DIM FR 0.91 MIN TO 0.60 MIN; CHG LD THICKNESS FR 0.35 $\pm$ 0.08 TO 0.20-0.35; ADD DRAFT ANGLE OF MOLDED BODY TOP & BOT; CHG LD LGTH TO PKG EDGE DIM TO BASIC; CHG LD PITCH FR 2.29 BS TO 2.30 BS; CHG BODY WID FR 3.56 $\pm$ 0.38 TO 3.30; CHG BODY LN FR 6.52 $\pm$ 0.38 TO 6.30; CHG TOTAL PKG WID FR 6.94 $\pm$ 0.38 TO 7.30; CHG PAD SIZE FR 0.99 MAX TO 0.95; CHG PAD PITCH FR 2.286 TO 2.30; CHG THERMAL TAB SIZE FR 3.28 MAX TO 3.25; CHG PAD SIZE FR 1.5 TO 1.90; CHG PAD SPACE FR 6.3 TO 6.10; CHG NOTE '2' TO 'A' W/O DATE; DEL NOTE ON LD FINISH; ADD NOTES B, C, D, E & F.	12FEB08	LZSC/FSCP

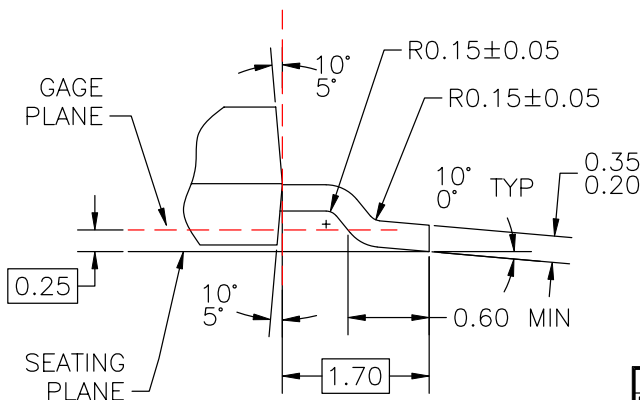


LAND PATTERN RECOMMENDATION





NOTES: UNLESS OTHERWISE SPECIFIED

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- B) DIMENSIONS ARE INCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR EXTRUSIONS.
- C) ALL DIMENSIONS ARE IN MILLIMETERS.
- D) DRAWING CONFORMS TO ASME Y14.5M-1994.
- E) LANDPATTERN NAME: SOT230P700X180-4BN
- F) DRAWING FILENAME: MKT-MA04AREV2



**DETAIL A**  
SCALE: 2:1

APPROVALS		DATE	
DRAWN: J.U. COMPARATIVO JR.		26FEB2008	
CHECKED: L.Z. STA CRUZ			
APPROVED: M.R. GESTOLE			
G.S. BAJE			
<div>PROJECTION</div> <div></div> <div>INCH</div>		<div></div> <div>MOLDED PACKAGE SOT-223, 4 LEAD</div>	
SCALE	1:1	SIZE	A3
DRAWING NUMBER	MKT-MA04A		REV
FORMERLY:	N/A		2
		SHEET : 1 OF 1	



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Rev. I72

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